

# Reverse-Engineering of Hardware Circuits

Jean-Luc Danger, Sylvain Guilley

Institut Mines TELECOM / TELECOM-ParisTech



## Presentation Outline

- 1 Introduction
- 2 Invasive techniques
  - Delaying / Tomography
  - Chip edition
- 3 Semi-invasive techniques
  - Preparation
  - Active / passive probing
  - FIRE
- 4 Non-invasive techniques
  - Temporal / spatial localization of the algorithm
- 5 Countermeasures against RE
  - White-box cryptography
  - Active shield against probing
  - Countermeasure against probing attacks
  - Hardware and software camouflage [GMN+13]

# Presentation Outline

- 1 Introduction
- 2 Invasive techniques
  - Delaying / Tomography
  - Chip edition
- 3 Semi-invasive techniques
  - Preparation
  - Active / passive probing
  - FIRE
- 4 Non-invasive techniques
  - Temporal / spatial localization of the algorithm
- 5 Countermeasures against RE
  - White-box cryptography
  - Active shield against probing
  - Countermeasure against probing attacks
  - Hardware and software camouflage [GMN+13]

# Definition of reverse-engineering

## Definition

- When the algorithm to attack is unknown, the system is a “black-box”.
- This means that the only way to attack is to analyze the input/output relationships  $\Rightarrow$  hard in general (but for cube attacks [DS09, DS10])
- Therefore, the first step is to recover the algorithm.

## Hardware versus Software reverse-engineering

- **Software:** The compiled code can be read-out from memories, and disassembled. Typically A5/1, A5/2, Hitag2 and Keeloq have been retrieved like that.
- **Hardware:** The functionality is buried into an ASIC.

# Goal of reverse-engineering

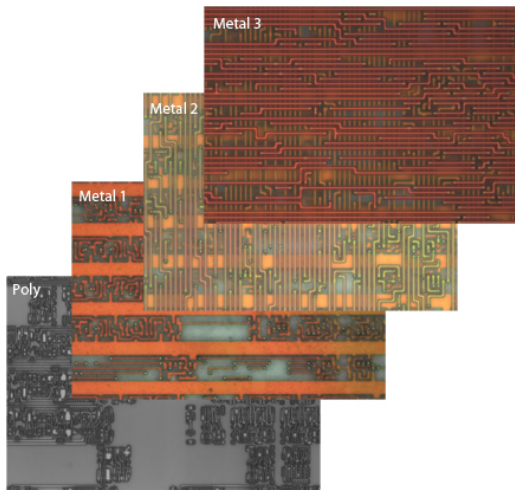
## Goals

- 1 Retrieving an algorithm and then cryptanalyse it:
  - This was the case of CRYPTO1 (MyFare) or DSC (DECT).
  - Indeed, the confidential algorithm is most often weak.
- 2 Breaking a protection:
  - Understand how memories are encrypted by a secure microcontroller [Mah97].
  - Afterwards, all the code is exposed.
  - It thus becomes easy to identify bugs, that can be exploited at the software-level.
  - Thanks to buffer overflows, take the control of the application.
- 3 Intellectual property matters:
  - Accessing the design of a competitor, so as to steal it.
  - Checking that the competitor does not infringe my patents.

# Presentation Outline

- 1 Introduction
- 2 Invasive techniques
  - Delaying / Tomography
  - Chip edition
- 3 Semi-invasive techniques
  - Preparation
  - Active / passive probing
  - FIRE
- 4 Non-invasive techniques
  - Temporal / spatial localization of the algorithm
- 5 Countermeasures against RE
  - White-box cryptography
  - Active shield against probing
  - Countermeasure against probing attacks
  - Hardware and software camouflage [GMN+13]

# Principle of Circuit Reverse-Engineering: Delayering

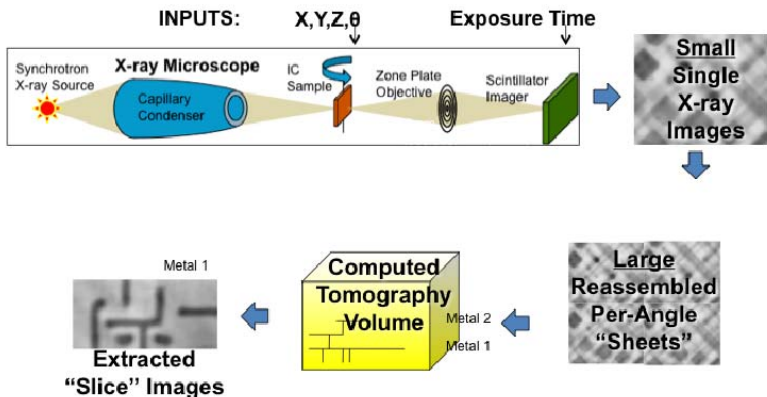


# Principle of Circuit Reverse-Engineering:

Tomography [BBT<sup>+</sup>11]

(see also [Zei13])

## X-ray Inspection Flowchart





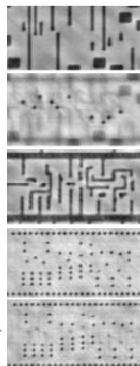
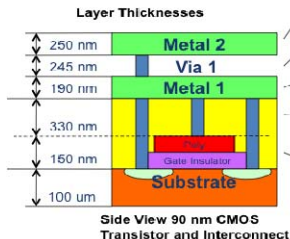
# Principle of Circuit Reverse-Engineering:

Tomography [BBT<sup>+</sup>11]

(see also [Zei13])

## Imaging Capability: Fine Feature Differentiation on Wiring Layers

Can differentiate finest scale features on smallest layers. E.g. Metal 1 is 190 nm thick with 120 nm feature size. "Lower contact" layer is 150 nm thick with 120 nm feature size.



Metal 2 (140 nm features)

Via 1 (140 nm features)

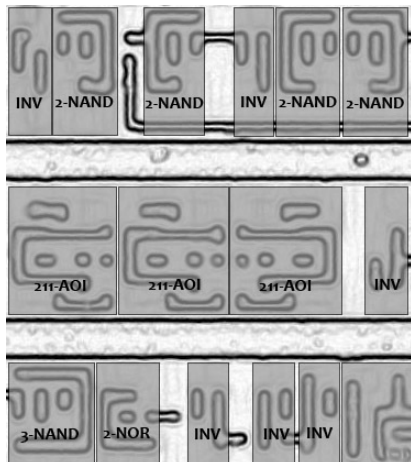
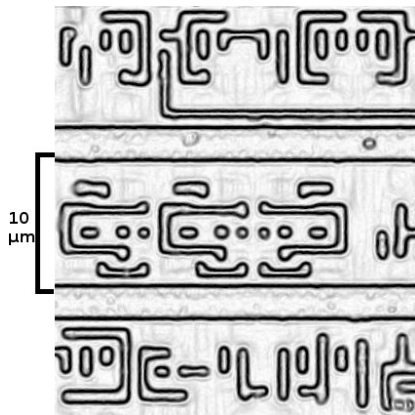
Metal 1 (120 nm features)

"Upper Contact" Layer (120 nm features) (above transistors)

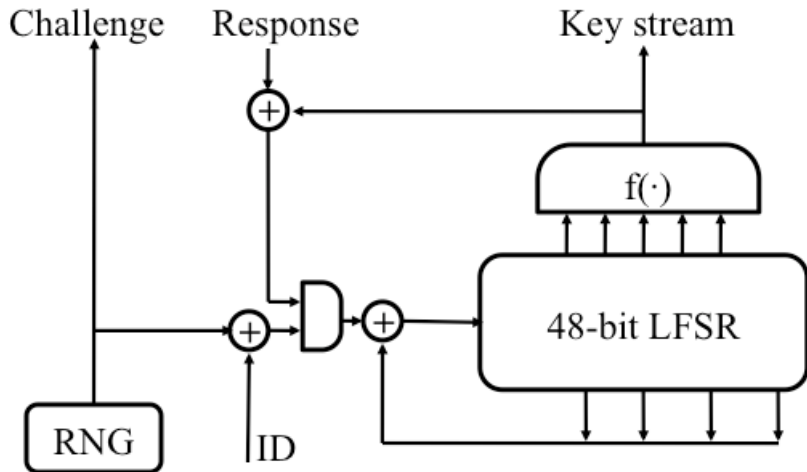
"Lower Contact" Layer (120 nm features) (below transistors)

6 μm x 3.6 μm "raw slices"  
of standard cell area

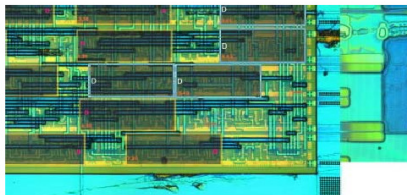
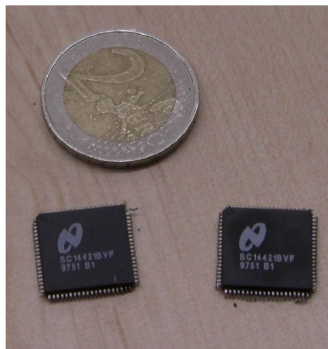
# Example of MyFare (NXP) [NSP08]



## Example of MyFare (NXP) – CRYPTO1 exposed [NSP08]

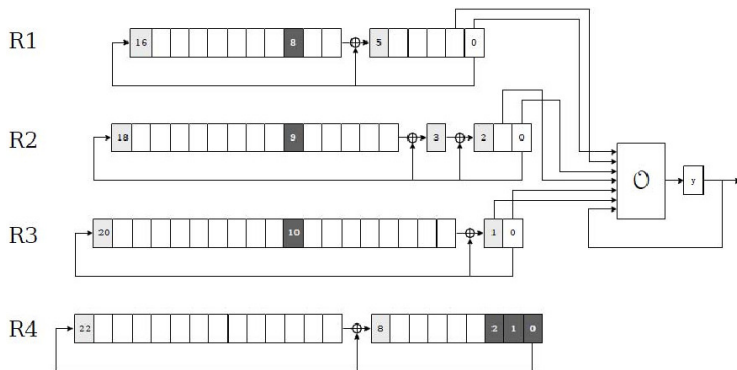


# Example of DECT (Alcatel) [NTW10]



See also: <https://deDECTed.org/>.

# Example of DECT (Alcatel) – DSC exposed [NTW10]

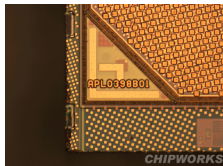


DSC = DECT Standard Cipher.

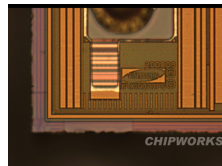
# Professional techniques

Example of <http://www.chipworks.com/> [TJ09] iPad tear-down (see also <http://www.ltecura.com/> and many others).

Apple / Microprocessor (with DRAM)



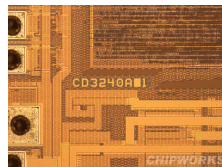
Samsung / 1 Gb mobile DDR SDRAM (x2)



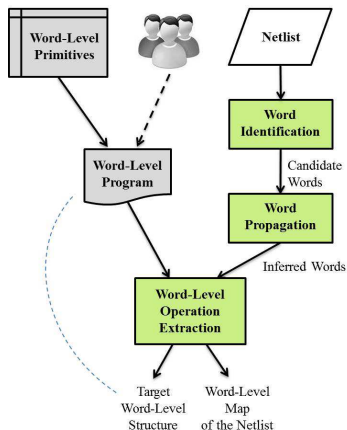
Broadcom / Microcontroller with NVM (used for touchscreen)



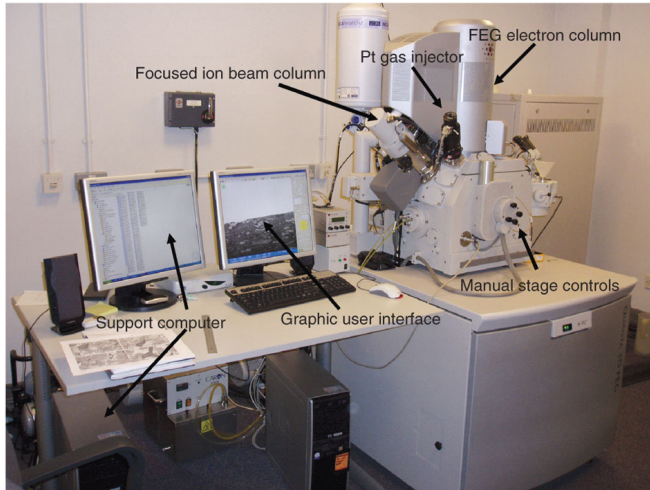
TI / Touchscreen line driver



# WordRev: Finding word-level structures in a sea of bit-level gates [LGS<sup>+</sup>13]

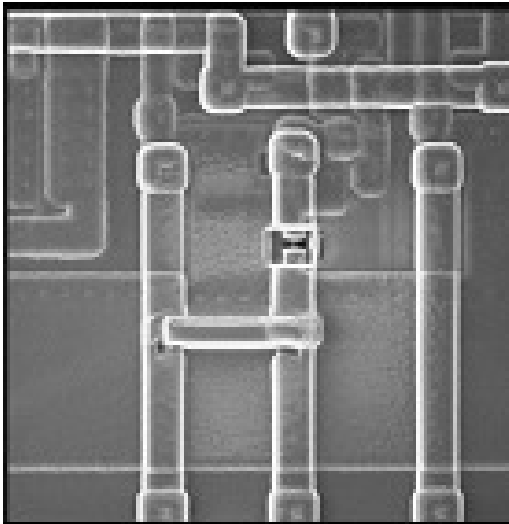


# Focused Ion Beam (FIB)



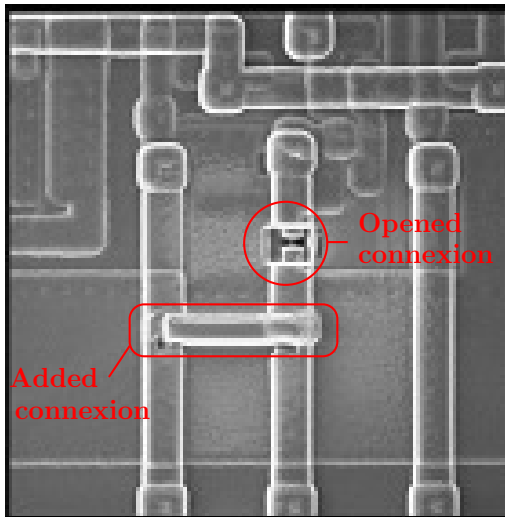


# Edition of a circuit thanks to a FIB (Focused Ion Beam)



Can be used for instance to unlock memories [Gir07].

# Edition of a circuit thanks to a FIB (Focused Ion Beam)

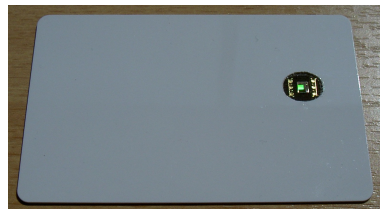
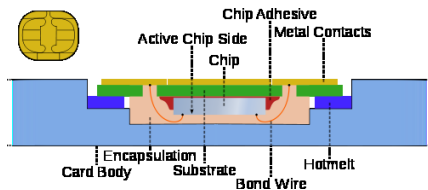


Can be used for instance to unlock memories [Gir07].

## Presentation Outline

- 1 Introduction
- 2 Invasive techniques
  - Delaying / Tomography
  - Chip edition
- 3 **Semi-invasive techniques**
  - **Preparation**
  - **Active / passive probing**
  - **FIRE**
- 4 Non-invasive techniques
  - Temporal / spatial localization of the algorithm
- 5 Countermeasures against RE
  - White-box cryptography
  - Active shield against probing
  - Countermeasure against probing attacks
  - Hardware and software camouflage [GMN+13]

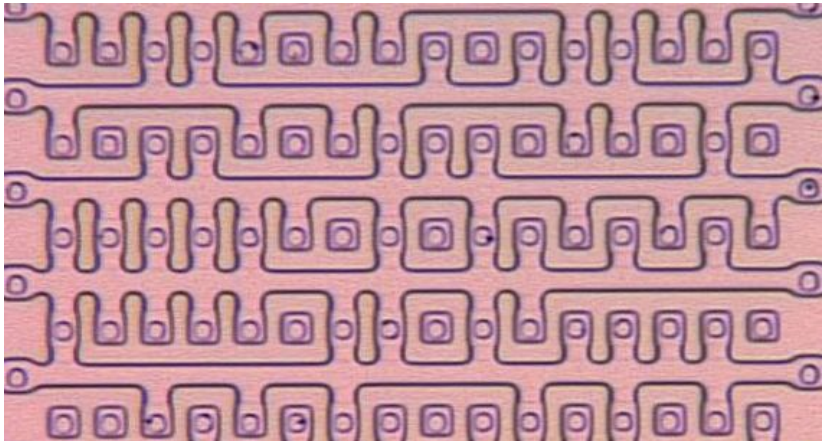
## Preparation of a smartcard front- and rear-side



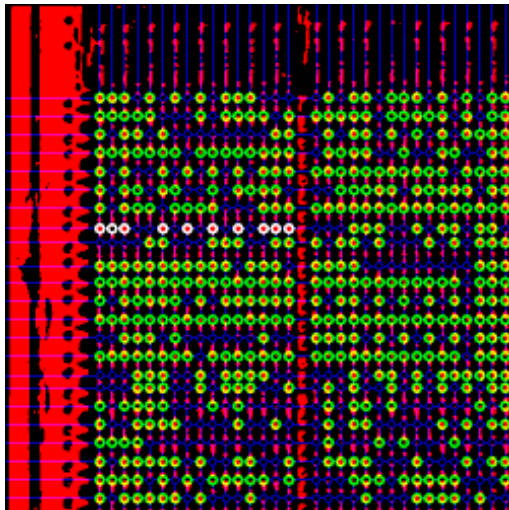
This chemical preparation enables probing and fault injection attacks.

## Reading ROMs [KK99]

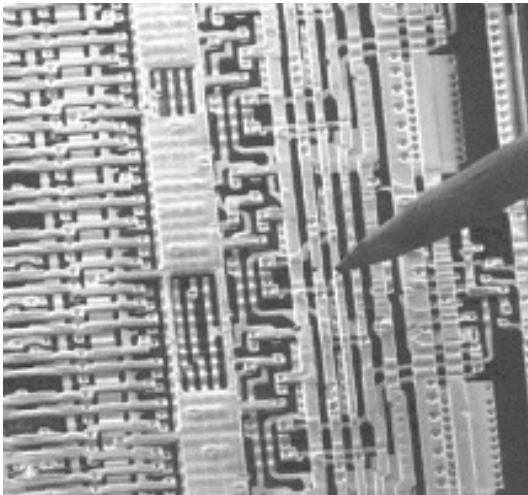
The image shows  $16 \times 10$  bits in an ST16xyz. Every bit is represented by either a present or missing diffusion layer connection.



## Semi-automatic extraction of ROM data (rompar)



## Needles can be used to actively / passively probe signals



- Can be used for instance to read keys as they circulate into the circuit.
- This technique gives the attacker a considerable power.
- However, probing stations allow to simultaneously read only a couple of bits [HPS99]... and only those that are on top of the circuit.

# Faults Injection Reverse-Engineering

## FIRE on DES / AES

- Already illustrated by Biham & Shamir (reconstructing unknown ciphers [BS97]) on Feistel schemes.
- Works on DES, because the attacker sees *inputs and outputs* differentials (improvement in [LBGRT13]).
- With secret encodings, it still works on DES, because the sbox is non-injective [Cla07].
- FIRE on SPNs (such as AES) is an emerging topic [PMG11].



## Presentation Outline

- 1 Introduction
- 2 Invasive techniques
  - Delaying / Tomography
  - Chip edition
- 3 Semi-invasive techniques
  - Preparation
  - Active / passive probing
  - FIRE
- 4 **Non-invasive techniques**
  - **Temporal / spatial localization of the algorithm**
- 5 Countermeasures against RE
  - White-box cryptography
  - Active shield against probing
  - Countermeasure against probing attacks
  - Hardware and software camouflage [GMN+13]

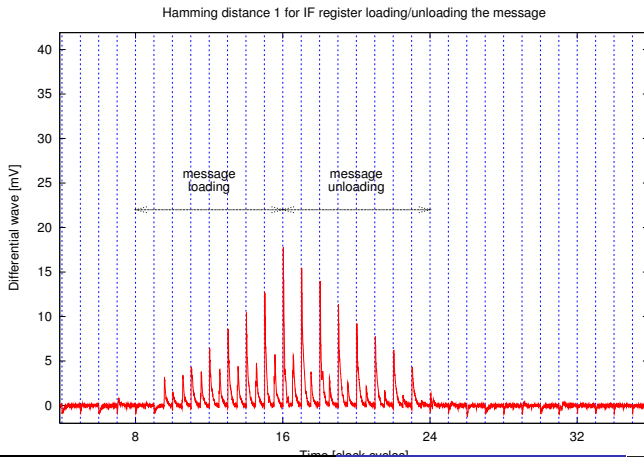
## Principle of temporal localization

Use **specific inputs** and **monitor the differences** via one side-channel. For instance, imagine that the key is known.

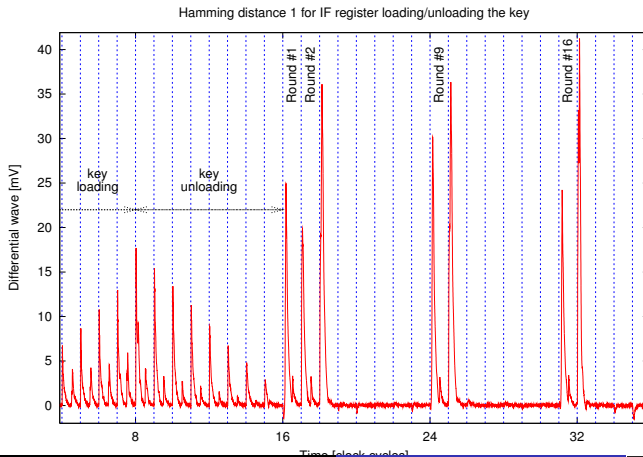
In the next three slides, we suggest to locate:

- 1 the plaintext loading,
- 2 the key loading,
- 3 the key schedule (diversification of the root key for each round).

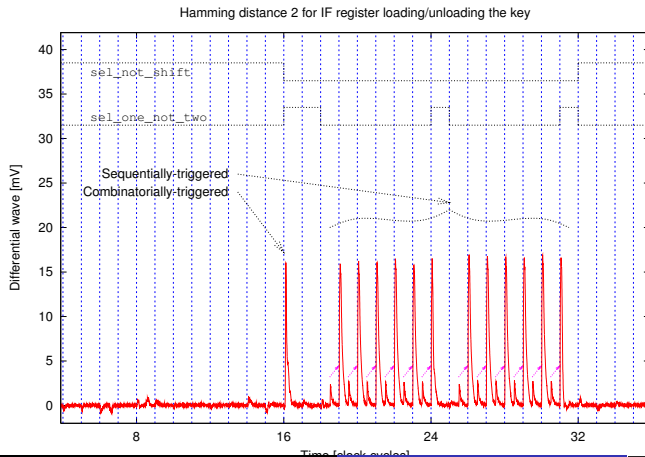
# Signature of message loading / unloading in IF (Reminder: IF is the InterFace register)



# Signature of key loading / unloading in IF, plus the CD activity

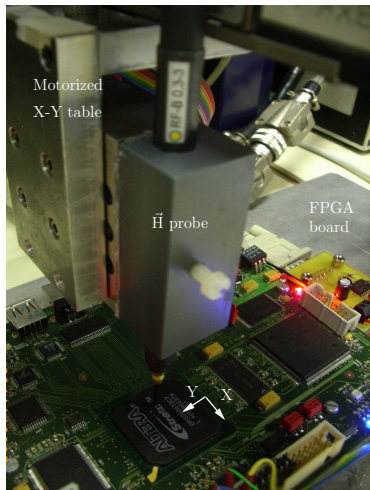


# Signature of distance-2 key loading / unloading in IF and of $LS^2$ in CD



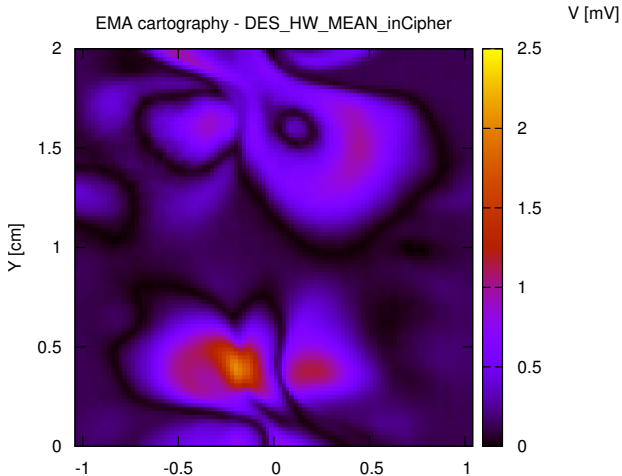
## Principle of spacial localization

Using an  $(X, Y)$  cartography tool



- Extension:  $(X, Y, Z, \theta)$  table.
- Helps identify zones that leak a lot; they do not necessarily correspond to the location of the modules! *Id est* they can maybe guide an attack by EMI but not by laser.

## Cartography results



## Presentation Outline

- 1 Introduction
- 2 Invasive techniques
  - Delaying / Tomography
  - Chip edition
- 3 Semi-invasive techniques
  - Preparation
  - Active / passive probing
  - FIRE
- 4 Non-invasive techniques
  - Temporal / spatial localization of the algorithm
- 5 Countermeasures against RE
  - White-box cryptography
  - Active shield against probing
  - Countermeasure against probing attacks
  - Hardware and software camouflage [GMN<sup>+</sup>13]

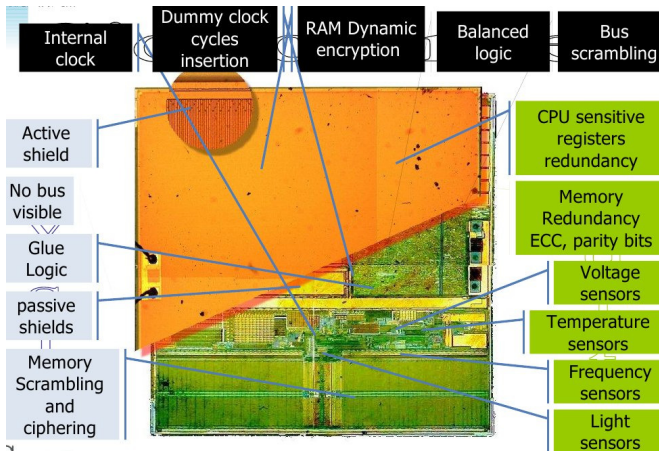


## Example of the white-box cryptography

### White-box cryptography [BCD09, CFD<sup>+</sup>10]

- **Principle:** provide everything (*i.e.* the compiled or the source code of the software) of an algorithm embedding a secret key.
- **Goal:** deny to the attacker the power of retrieving the couple (algorithm + key).

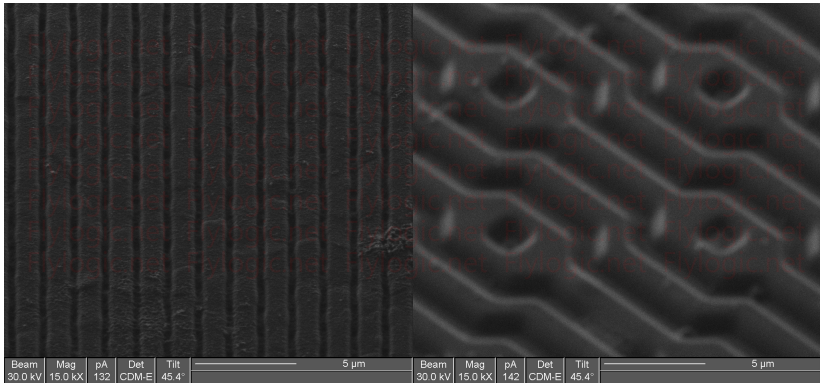
# A summary of the countermeasures embedded in a smartcard



Courtesy of Assia Tria, CEA/LETI.

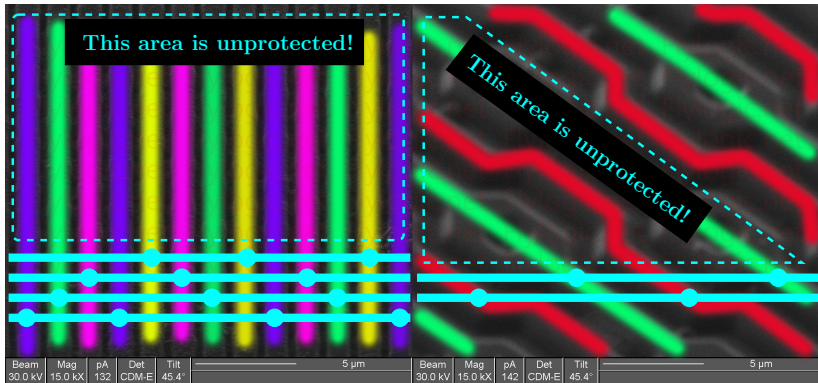
# Active shield

1/2



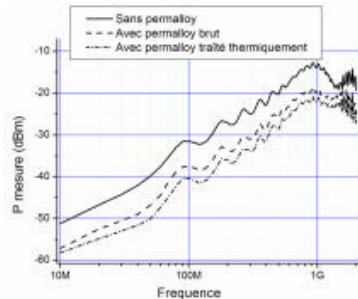
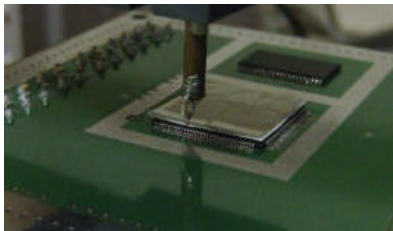
# Active shield

2/2



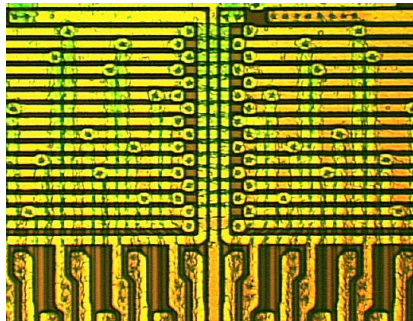
## Radiation suppression with a ferromagnetic film

Ferromagnetic material  $\text{Ni}_{80}\text{Fe}_{20}$ , aka Permalloy.  
Experiment with a layer of  $20\ \mu\text{m}$  depth [BBD<sup>+</sup>07].



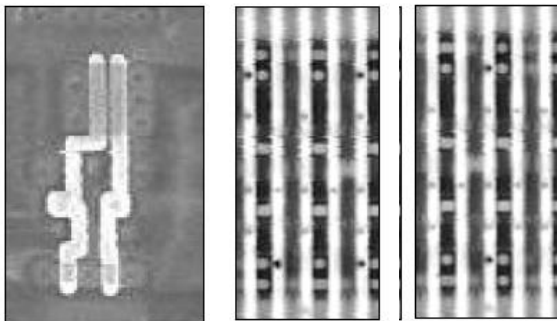
## Bus scrambling

- Scrambling can be static or dynamic.
- Static scrambling can also be a feature
  - The mixing comes from a problem of routability of the data/address bus to the memory.
  - Possible because permutations affect equally the write and read operations.



Beware of attacks [FLM10] on scrambled EEPROMs!

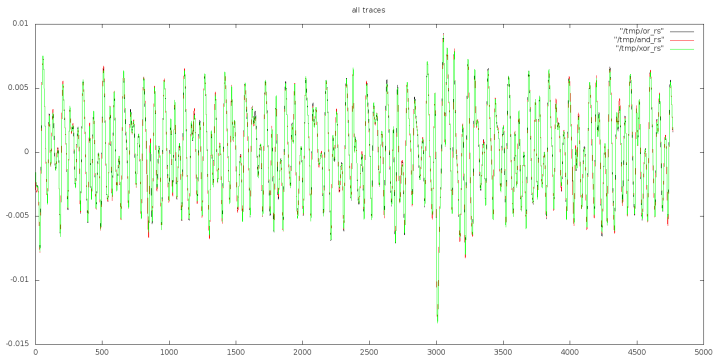
## Hardware Camo



Hardware-level camouflage of gates. Left: an unprotected gate, whose function is easy to identify. Center, right: *almost* indistinguishable AND/OR camouflaged gates. [courtesy of SMI / SypherMedia Library]

## Software Camo

## ARM7 Native Machine Code



Traces of the electromagnetic leakage of the AND, XOR and OR



- [BBD<sup>+</sup>07] L. Bouhouch, A. Boyer, S. Ben Dhia, É. Sicard, and M. Fadel.  
Amélioration des performances CEM d'un microcontrôleur à l'aide d'un film ferromagnétique.  
In *TELECOM 2007, 5th JFMMA*, March 2007.  
Fes, Morocco. ([Online PDF](#)).
- [BBT<sup>+</sup>11] M. Bajura, G. Boverman, J. Tan, G. Wagenbreth, C. M. Rogers, M. Feser, J. Rudati, A. Tkachuk, S. Aylward, and P. Reynolds.  
Imaging Integrated Circuits with X-ray Microscopy.  
In *Proceedings of the 36th GOMACTech Conference*, March 2011.  
Orlando, FL, USA.  
[http://www-ssrl.slac.stanford.edu/research/highlights\\_archive/circuitintegrity.pdf](http://www-ssrl.slac.stanford.edu/research/highlights_archive/circuitintegrity.pdf).
- [BCD09] Julien Bringer, Hervé Chabanne, and Jean-Luc Danger.  
Protecting the NOEKEON Cipher against SCARE Attacks in FPGAs by Using Dynamic Implementations.  
In *ReConFig*, pages 183–188. IEEE Computer Society, December 9–11 2009.  
Cancún, Quintana Roo, México. DOI: 10.1109/ReConFig.2009.19,  
<http://eprint.iacr.org/2009/239.pdf>.
- [BS97] Eli Biham and Adi Shamir.  
Differential Fault Analysis of Secret Key Cryptosystems.  
In *CRYPTO*, volume 1294 of *LNCS*, pages 513–525. Springer, August 1997.  
Santa Barbara, California, USA. DOI: 10.1007/BFb0052259.
- [CFD<sup>+</sup>10] Zouha Cherif, Florent Flament, Jean-Luc Danger, Shivam Bhasin, Sylvain Guilley, and Hervé Chabanne.  
Evaluation of White-Box and Grey-Box Noekeon Implementations in FPGA.  
In Viktor K. Prasanna, Jürgen Becker, and René Cumplido, editors, *ReConFig*, pages 310–315. IEEE Computer Society, 2010.

- [Cla07] Christophe Clavier.  
Secret External Encodings Do Not Prevent Transient Fault Analysis.  
In *CHES*, volume 4727 of *Lecture Notes in Computer Science*, pages 181–194. Springer, 2007.  
Vienna, Austria.
- [DS09] Itai Dinur and Adi Shamir.  
Side Channel Cube Attacks on Block Ciphers.  
Cryptology ePrint Archive, Report 2009/127, March 2009.  
<http://eprint.iacr.org/2009/127/>.
- [DS10] Itai Dinur and Adi Shamir.  
Generic Analysis of Small Cryptographic Leaks.  
In *FDTC*, pages 39–48. IEEE Computer Society, August 21 2010.  
Santa Barbara, CA, USA. DOI: 10.1109/FDTC.2010.11.
- [FLM10] Jacques J. A. Fournier and Philippe Loubet-Moundi.  
Memory Address Scrambling Revealed Using Fault Attacks.  
In *FDTC*, pages 30–36. IEEE Computer Society, August 21 2010.  
Santa Barbara, CA, USA. DOI: 10.1109/FDTC.2010.13.
- [Gir07] Christophe Giraud.  
*Attaques de cryptosystèmes embarqués et contre-mesures associées.*  
PhD thesis, Université de Versailles Saint-Quentin-en-Yvelines, 26 octobre 2007.  
<http://www.prism.uvsq.fr/fileadmin/CRYPTO/TheseCG-new.pdf>.
- [GMN<sup>+</sup>13] Sylvain Guilley, Damien Marion, Zakaria Najm, Youssef Souissi, and Antoine Wurcker.  
Software Camouflage.  
In *FPS*, volume 8352 of *LNCS*. Springer, October, 21–22 2013.  
La Rochelle, France.

- [HPS99] Helena Handschuh, Pascal Paillier, and Jacques Stern.  
Probing Attacks on Tamper-Resistant Devices.  
In *CHES*, volume 1717 of *LNCS*, pages 303–315. Springer, August 12-13 1999.  
Worcester, MA, USA.
- [KK99] Oliver Kömmerling and Markus G. Kuhn.  
Design Principles for Tamper-Resistant Smartcard Processors.  
In *WOST '99 (USENIX Workshop on Smartcard Technology)*, pages 9–20, Berkeley, CA, USA, May 10-11 1999. USENIX Association.  
Chicago, Illinois, USA ([On-line paper](#)). ISBN: 1-880446-34-0.
- [LBGRT13] H el ene Le Boudier, Sylvain Guilley, Bruno Robisson, and Assia Tria.  
Fault Injection to Reverse Engineer DES-like Cryptosystems.  
In *FPS*, volume 8352 of *LNCS*. Springer, October, 21–22 2013.  
La Rochelle, France.
- [LGS<sup>+</sup>13] Wenchao Li, Adria Gasc on, Pramod Subramanyan, Wei Yang Tan, Ashish Tiwari, Sharad Malik, Natarajan Shankar, and Sanjit A. Seshia.  
WordRev: Finding word-level structures in a sea of bit-level gates.  
In *HOST*, pages 67–74. IEEE, 2013.
- [Mah97] David Paul Maher.  
Fault Induction Attacks, Tamper Resistance, and Hostile Reverse Engineering in Perspective.  
In *Financial Cryptography*, volume 1318 of *Lecture Notes in Computer Science*, pages 109–122.  
Springer, February 24-28 1997.
- [NSP08] Karsten Nohl, David Evans Starbug, and Henryk Pl otz.  
Reverse-Engineering a Cryptographic RFID Tag.  
In *USENIX Security Symposium*, pages 185–193, July 31 2008.  
San Jose, CA, USA ([Online HTML](#)).

- [NTW10] Karsten Nohl, Erik Tews, and Ralf-Philipp Weinmann.  
Cryptanalysis of the DECT Standard Cipher.  
In *FSE*, volume 6147 of *Lecture Notes in Computer Science*, pages 1–18. Springer, February 7-10 2010.  
Seoul, South Korea.
- [PMG11] Manuel San Pedro, Soos Mate, and Sylvain Guilley.  
FIRE: Fault Injection for Reverse Engineering.  
In LNCS, editor, *WISTP: Information Security Theory and Practices. Smart Cards, Mobile and Ubiquitous Computing*, volume 6633 of LNCS, pages 280–293. Springer, June 1-3 2011.  
Heraklion, Greece. DOI: 10.1007/978-3-642-21040-2\_20.
- [TJ09] Randy Torrance and Dick James.  
The State-of-the-Art in IC Reverse Engineering.  
In *CHES*, volume 5747 of LNCS, pages 363–381. Springer, September 6-9 2009.  
Lausanne, Switzerland.
- [Ze13] Carl Zeiss.  
Package Optimization and Failure Analysis with 3D X-ray Microscopy, November 2013.  
<https://zeiss-microscopy.uberflip.com/i/547299-package-optimization-and-failure-analysis-with-3d-x-ray-microscopy>.